

1. Description

The KIA40N06B is the highest performance trench N-ch MOSFETs with extreme high cell density, which provide excellent $R_{DS(on)}$ and gate charge for most of the synchronous buck converter applications. The KIA40N06B meet the RoHS and Green Product requirement, 100% EAS guaranteed with full function reliability approved.

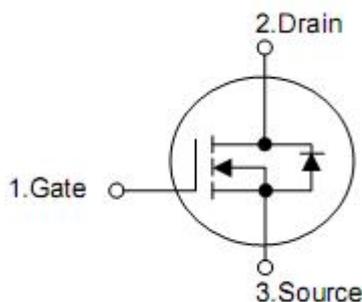
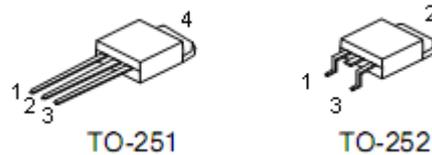
2. Features

- $R_{DS(on)}=18m\Omega @ V_{DS}=60V$
- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent $C_{dv/dt}$ effect decline
- 100% EAS Guaranteed
- Green Device Available

3. Applications

- High Frequency Point-of-Load Synchronous Buck Converter for MB/NB/UMPC/VGA
- Networking DC-DC Power System
- LCD/LED back light

4. Symbol



Pin	Function
1	Gate
2	Drain
3	Source

5. Absolute maximum ratings

Parameter	Symbol	Rating	Units	
Drain-source voltage	V_{DS}	60	V	
Gate-source voltage	V_{GS}	+20	V	
Continuous drain current, $V_{GS}@10V^1$	I_D	$T_C=25^\circ C$	38	A
		$T_C=100^\circ C$	30	A
Pulsed drain current ²	I_{DM}	80	A	
Single pulse avalanche energy ³	E_{AS}	67	mJ	
Avalanche current	I_{AS}	28	A	
Total power dissipation ⁴	P_D	45	W	
Operation junction temperature range	T_J	-55 to 150	$^\circ C$	
Storage temperature range	T_{STG}	-55 to 150	$^\circ C$	

6. Thermal characteristics

Parameter	Symbol	Typ	Max	Unit
Thermal resistance, Junction-ambient ¹	$R_{\theta JA}$	--	62	$^\circ C/W$
Thermal resistance, Junction-case ¹	$R_{\theta JC}$	--	2.8	

7. Electrical characteristics

($T_J=25^{\circ}\text{C}$, unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Units
Drain-source breakdown voltage	BV_{DSS}	$V_{GS}=0V, I_D=250\mu A$	60	-	-	V
BV_{DSS} temperature coefficient	$\Delta BV_{DSS}/\Delta T_J$	Reference to 25°C , $I_D=1mA$		0.057		$V/^{\circ}\text{C}$
Static drain-source on-resistance ²	$R_{DS(on)}$	$V_{GS}=10V, I_D=15A$		14	18	m Ω
		$V_{GS}=4.5V, I_D=10A$		16	20	
Gate threshold voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	1.2		2.5	V
$V_{GS(th)}$ temperature coefficient	$\Delta V_{GS(th)}$			-5.68		$mV/^{\circ}\text{C}$
Drain-source leakage current	I_{DSS}	$V_{DS}=48V, V_{GS}=0V$ $T_J=25^{\circ}\text{C}$			1	μA
		$V_{DS}=48V, V_{GS}=0V$ $T_J=55^{\circ}\text{C}$			5	μA
Gate- source leakage current	I_{GSS}	$V_{GS}=\pm 20V, V_{DS}=0V$			± 100	nA
Forward transconductance	g_{fs}	$V_{DS}=5V, I_D=15A$		45		S
Gate resistance	R_g	$V_{DS}=0V, V_{GS}=0V, f=1MHz$		1.7	3.4	Ω
Total gate charge(4.5V)	Q_g	$V_{DS}=48V, V_{GS}=4.5V$ $I_D=12A$	-	17.6		nC
Gate-source charge	Q_{gs}		5.35			
Gate-drain charge	Q_{gd}		6.81			
Turn-on delay time	$t_{d(on)}$	$V_{DD}=15V, I_D=1A,$ $R_G=3.3\Omega, V_{GS}=10V$		15.5		ns
Rise time	t_r			2.2		
Turn-off delay time	$t_{d(off)}$			72.8		
Fall time	t_f			3.8		
Input capacitance	C_{iss}	$V_{DS}=15V, V_{GS}=0V,$ $f=1MHz$		2423		pF
Output capacitance	C_{oss}			145		
Reverse transfer capacitance	C_{rss}			97		
Single pulse avalanche energy ⁵	EAS	$V_{DD}=25V, L=0.1mH,$ $I_{AS}=15A$	19			mJ
Continuous source current ^{1,6}	I_S	$V_G=V_D=0V,$ Force current			38	A
Pulsed source current ^{2,6}	I_{SM}				80	A
Diode forward voltage ²	V_{SD}	$V_{GS}=0V, I_S=1A, T_J=25^{\circ}\text{C}$			1	V

Note:1.The data tested by surface mounted on a 1 inch² FR-4 board with 20Z copper.

2.The data tested by pulsed, pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$

3.The EAS data shows Max.rating.The test condition is $V_{DD}=25V, V_{GS}=10V, L=0.1mH, I_{AS}=28A$

4.The power dissipation is limited by 150°C junction temperature

5.The Min, value is 100% EAS tested guarantee.

6.The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.

8. Test circuits and waveforms

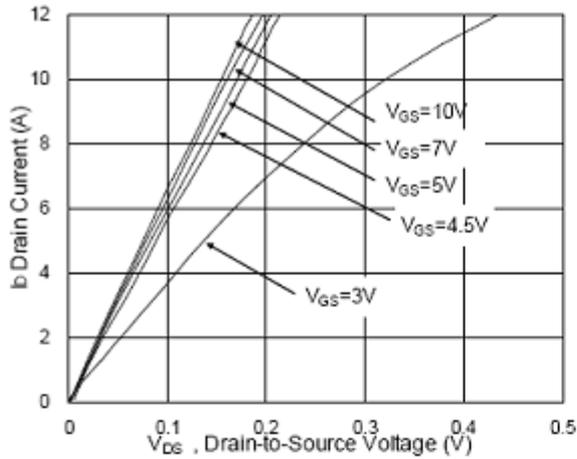


Fig.1 Typical Output Characteristics

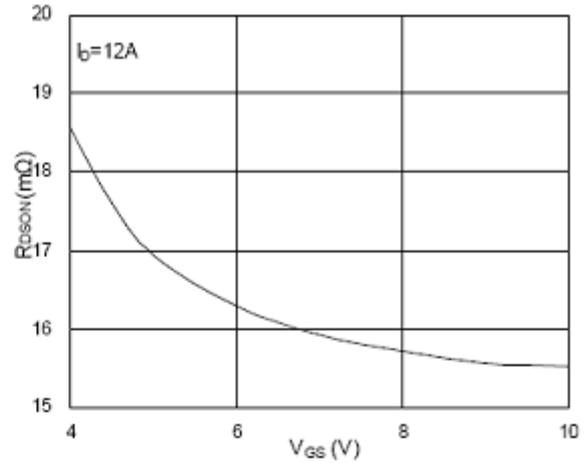


Fig.2 On-Resistance v.s Gate-Source.

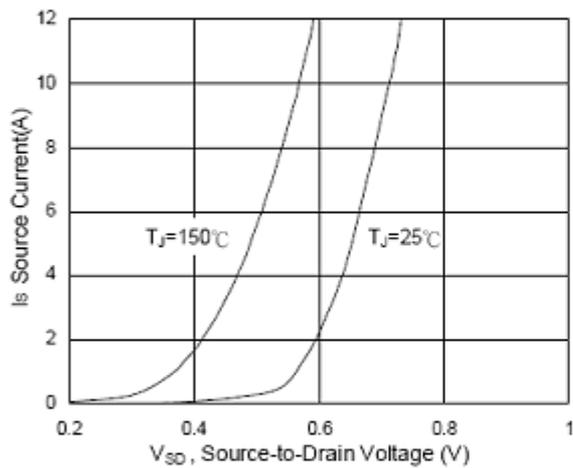


Fig.3 Forward Characteristics of Reverse

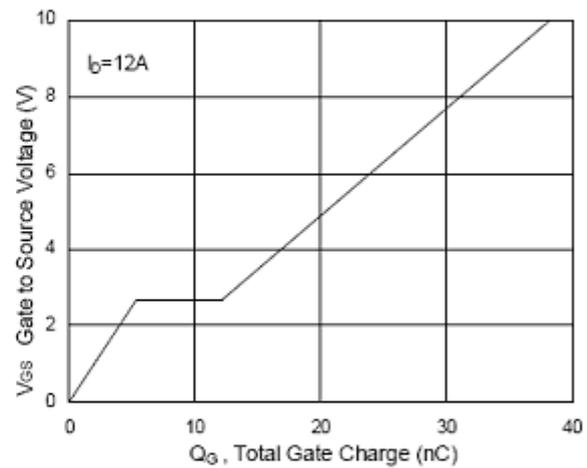


Fig.4 Gate-Charge characteristics

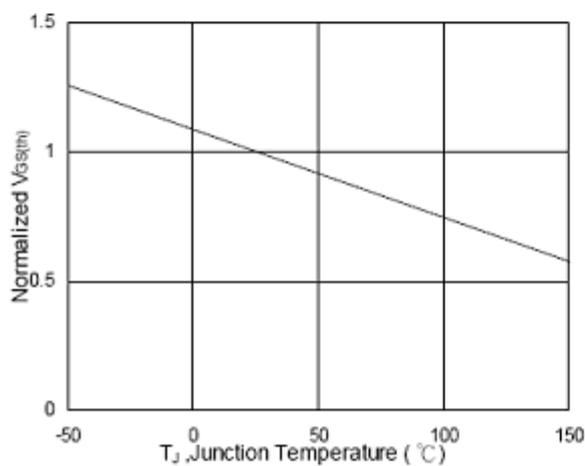


Fig.5 Normalized V_{GS(th)} v.s T_J

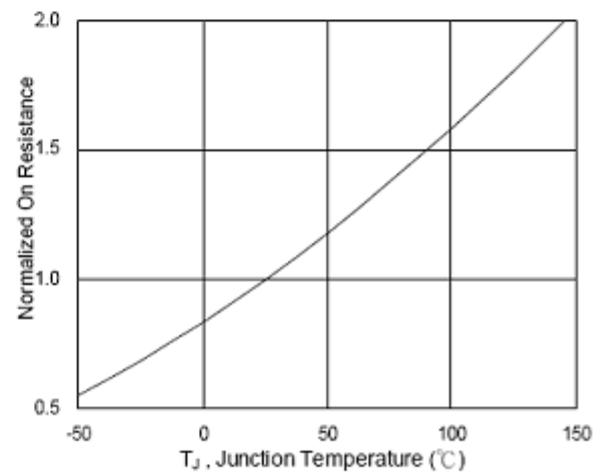
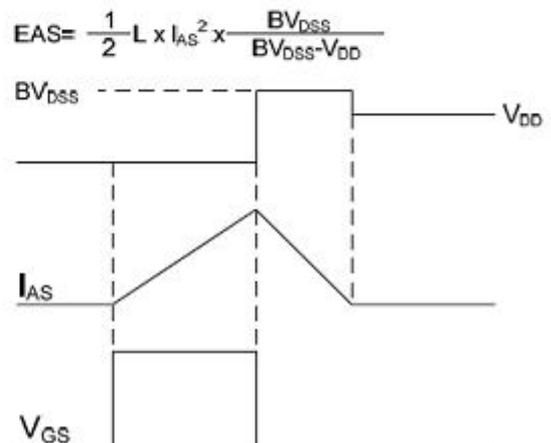
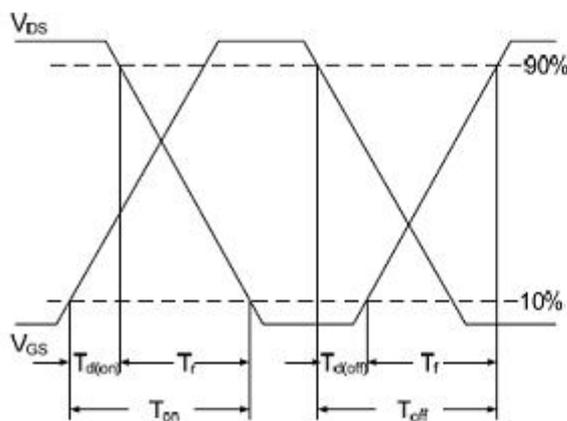
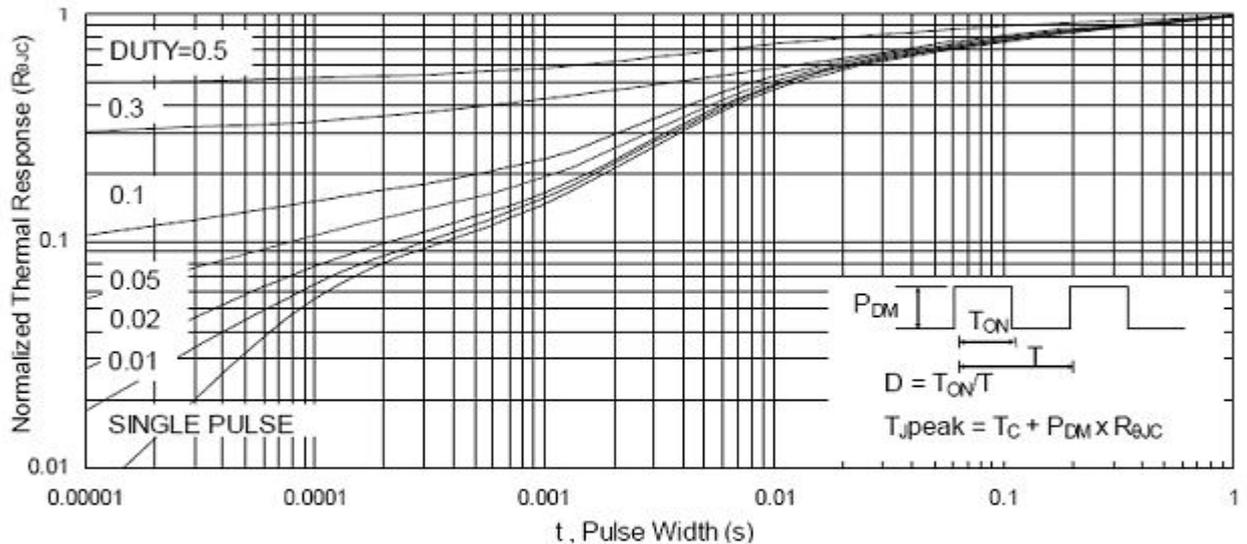
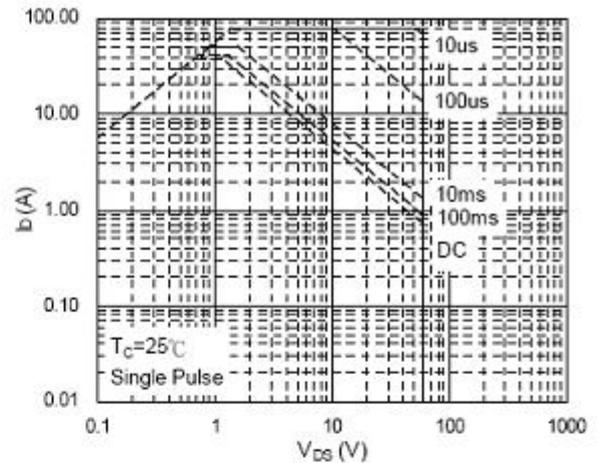
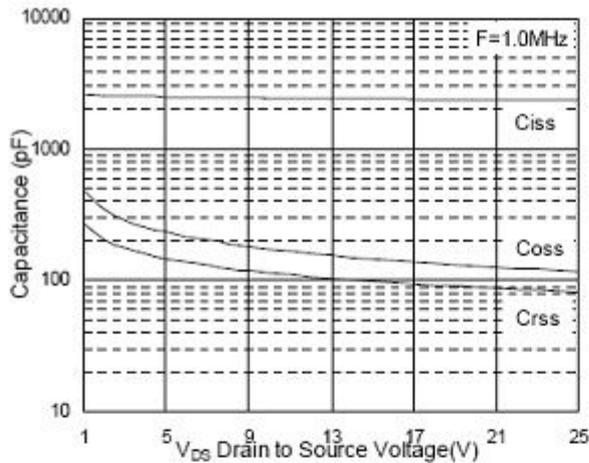


Fig.6 Normalized R_{DS(on)} v.s T_J



$$EAS = \frac{1}{2} L \times I_{AS}^2 \times \frac{BV_{DSS}}{BV_{DSS} - V_{DD}}$$